

MC10EL89

5V ECL Coaxial Cable Driver

The MC10EL89 is a differential fanout gate specifically designed to drive coaxial cables. The device is especially useful in Digital Video Broadcasting applications; for this application, since the system is polarity free, each output can be used as an independent driver. The driver boasts a gain of approximately 40 and produces output swings twice as large as a standard ECL output. When driving a coaxial cable, proper termination is required at both ends of the line to minimize signal loss. The 1.6 V output swings allow for termination at both ends of the cable, while maintaining the required 800 mV swing at the receiving end of the cable. Because of the larger output swings, the device cannot be terminated into the standard -2.0 V. All of the DC parameters are tested with a 50Ω to -3.0 V load. The driver accepts a standard differential ECL input and can run off of the Digital Video Broadcast standard -5.0 V supply.

Features

- 375 ps Propagation Delay
- 1.6 V Output Swings
- PECL Mode Operating Range: $V_{CC} = 4.2$ V to 5.7 V with $V_{EE} = 0$ V
- NECL Mode Operating Range: $V_{CC} = 0$ V with $V_{EE} = -4.2$ V to -5.7 V
- Internal Input Pulldown Resistors
- Pb-Free Packages are Available

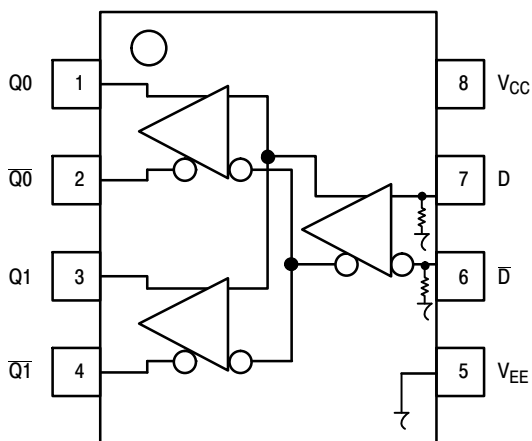


Figure 1. Logic Diagram and Pinout Assignment



ON Semiconductor®

<http://onsemi.com>

MARKING DIAGRAMS*



SOIC-8
D SUFFIX
CASE 751



TSSOP-8
DT SUFFIX
CASE 948R



DFN8
MN SUFFIX
CASE 506AA

- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
- M̄ = Date Code
- = Pb-Free Package

(Note: Microdot may be in either location)

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

MC10EL89

Table 1. PIN DESCRIPTION

| PIN | Function |
|---------------------------------|--|
| D, \bar{D} | ECL Data Inputs |
| Q0, $\bar{Q0}$; Q1, $\bar{Q1}$ | ECL Data Outputs (1.6 V _{pp}) |
| V _{CC} | Positive Supply |
| V _{EE} | Negative Supply |
| EP | (DFN8 only) Thermal exposed pad must be connected to a sufficient thermal conduit. Electrically connect to the most negative supply (GND) or leave unconnected, floating open. |

Table 2. ATTRIBUTES

| Characteristics | Value |
|---|-----------------------------------|
| Internal Input Pulldown Resistor | 50 K Ω |
| Internal Input Pullup Resistor | N/A |
| ESD Protection | Human Body Model Machine Model |
| | > 2 kV > 100 V |
| Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1) | Level 1 |
| Flammability Rating | Oxygen Index: 28 to 34 |
| | UL 94 V-0 @ 0.125 in |
| Transistor Count | 31 |
| Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test | |

1. For additional information, see Application Note AND8003/D.

Table 3. MAXIMUM RATINGS

| Symbol | Parameter | Condition 1 | Condition 2 | Rating | Unit |
|------------------|--|--|--|---------------|--------------|
| V _{CC} | PECL Mode Power Supply | V _{EE} = 0 V | | 8 | V |
| V _{EE} | NECL Mode Power Supply | V _{CC} = 0 V | | -8 | V |
| V _I | PECL Mode Input Voltage NECL Mode Input Voltage | V _{EE} = 0 V V _{CC} = 0 V | V _I ≤ V _{CC} V _I ≥ V _{EE} | 6 -6 | V V |
| I _{out} | Output Current | Continuous Surge | | 50 100 | mA mA |
| T _A | Operating Temperature Range | | | -40 to +85 | °C |
| T _{stg} | Storage Temperature Range | | | -65 to +150 | °C |
| θ_{JA} | Thermal Resistance (Junction-to-Ambient) | 0 lfpm 500 lfpm | SO-8 SO-8 | 190 130 | °C/W °C/W |
| θ_{JC} | Thermal Resistance (Junction-to-Case) | Standard Board | SO-8 | 41 to 44 | °C/W |
| θ_{JA} | Thermal Resistance (Junction-to-Ambient) | 0 lfpm 500 lfpm | TSSOP-8 TSSOP-8 | 185 140 | °C/W °C/W |
| θ_{JC} | Thermal Resistance (Junction-to-Case) | Standard Board | TSSOP-8 | 41 to 44 ± 5% | °C/W |
| θ_{JA} | Thermal Resistance (Junction-to-Ambient) | 0 lfpm 500 lfpm | DFN8 DFN8 | 129 84 | °C/W °C/W |
| T _{sol} | Wave Solder | Pb Pb-Free | <2 to 3 sec @ 248°C <2 to 3 sec @ 260°C | 265 265 | °C |
| θ_{JC} | Thermal Resistance (Junction-to-Case) | (Note 2) | DFN8 | 35 to 40 | °C/W |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

2. JEDEC standard multilayer board – 2S2P (2 signal, 2 power)

MC10EL89

Table 4. 10EL SERIES PECL DC CHARACTERISTICS $V_{CC} = 5.0\text{ V}$; $V_{EE} = 0.0\text{ V}$ (Note 3)

| Symbol | Characteristic | -40°C | | | 25°C | | | 85°C | | | Unit |
|-------------|--|-------|------|------|------|------|------|------|------|------|---------------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| I_{EE} | Power Supply Current | | 23 | 28 | | 23 | 28 | | 23 | 28 | mA |
| V_{OH} | Output HIGH Voltage (Note 4) | 3.77 | 3.90 | 4.02 | 3.87 | 3.98 | 4.10 | 3.94 | 4.04 | 4.19 | V |
| V_{OL} | Output LOW Voltage (Note 4) | 2.10 | 2.28 | 2.42 | 2.00 | 2.30 | 2.44 | 1.95 | 2.33 | 2.49 | V |
| V_{IH} | Input HIGH Voltage (Single-Ended) | 3770 | | 4110 | 3870 | | 4190 | 3940 | | 4280 | mV |
| V_{IL} | Input LOW Voltage (Single-Ended) | 3050 | | 3500 | 3050 | | 3520 | 3050 | | 3555 | mV |
| V_{IHCMR} | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 5) | 2.5 | | 4.6 | 2.5 | | 4.6 | 2.5 | | 4.6 | V |
| I_{IH} | Input HIGH Current | | 70 | 150 | | 50 | 150 | | 40 | 150 | μA |
| I_{IL} | Input LOW Current | 0.5 | 50 | | 0.5 | 30 | | 0.3 | 25 | | μA |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary +0.25 V / -0.5 V.
- Outputs are terminated through a 50 Ω resistor to $V_{CC} - 3.0\text{ V}$.
- V_{IHCMR} min varies 1:1 with V_{EE} . V_{IHCMR} max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{ppmin} and 1 V.

Table 5. 10EL SERIES NECL DC CHARACTERISTICS $V_{CC} = 0.0\text{ V}$; $V_{EE} = -5.0\text{ V}$ (Note 6)

| Symbol | Characteristic | -40°C | | | 25°C | | | 85°C | | | Unit |
|-------------|--|-----------|-------|-----------|-----------|-------|-----------|-----------|-------|-----------|---------------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| I_{EE} | Power Supply Current | | 23 | 28 | | 23 | 28 | | 23 | 28 | mA |
| V_{OH} | Output HIGH Voltage (Note 7) | -1.23 | -1.10 | -0.98 | -1.13 | -1.02 | -0.90 | -1.06 | -0.96 | -0.81 | V |
| V_{OL} | Output LOW Voltage (Note 7) | -2.90 | -2.72 | -2.58 | -3.00 | -2.70 | -2.56 | -3.05 | -2.67 | -2.51 | V |
| V_{IH} | Input HIGH Voltage (Single-Ended) | -123 0 | | -890 | -1130 | | -810 | -106 0 | | -720 | mV |
| V_{IL} | Input LOW Voltage (Single-Ended) | -195 0 | | -150 0 | -195 0 | | -148 0 | -195 0 | | -144 5 | mV |
| V_{IHCMR} | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 8) | -2.5 | | -0.4 | -2.5 | | -0.4 | -2.5 | | -0.4 | V |
| I_{IH} | Input HIGH Current | | 70 | 150 | | 50 | 150 | | 20 | 150 | μA |
| I_{IL} | Input LOW Current | 0.5 | 50 | | 0.5 | 30 | | 0.3 | 25 | | μA |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary +0.25 V / -0.5 V.
- Outputs are terminated through a 50 Ω resistor to $V_{CC} - 3.0\text{ V}$.
- V_{IHCMR} min varies 1:1 with V_{EE} . V_{IHCMR} max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{ppmin} and 1 V.

MC10EL89

Table 6. AC CHARACTERISTICS $V_{CC} = 5.0\text{ V}$; $V_{EE} = 0.0\text{ V}$ or $V_{CC} = 0.0\text{ V}$; $V_{EE} = -5.0\text{ V}$ (Note 9)

| Symbol | Characteristic | -40°C | | | 25°C | | | 85°C | | | Unit |
|------------------------|--------------------------------------|-------|-----|-----|------|-----|-----|------|-----|-----|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| f_{\max} | Maximum Toggle Frequency | | | | | 1.5 | | | | | Gb/s |
| t_{PLH} t_{PHL} | Propagation Delay to Output | 200 | 340 | 480 | 260 | 350 | 440 | 310 | 400 | 490 | ps |
| t_{SKEW} | Within-Device Skew | | 5 | 20 | | 5 | 20 | | 5 | 20 | ps |
| t_{JITTER} | Random Clock Jitter (RMS) | | 5 | | | 5 | | | 5 | | ps |
| V_{PP} | Input Swing (Note 10) | 150 | | | 150 | 400 | | 150 | | | mV |
| t_r t_f | Output Rise/Fall Times Q (20% - 80%) | 205 | 330 | 455 | 205 | 330 | 455 | 205 | 330 | 455 | ps |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

9. V_{EE} can vary +0.25 V / -0.5 V.

10. $V_{PP(\min)}$ is the minimum input swing for which AC parameters are guaranteed. The device has a DC gain of ≈ 40 .

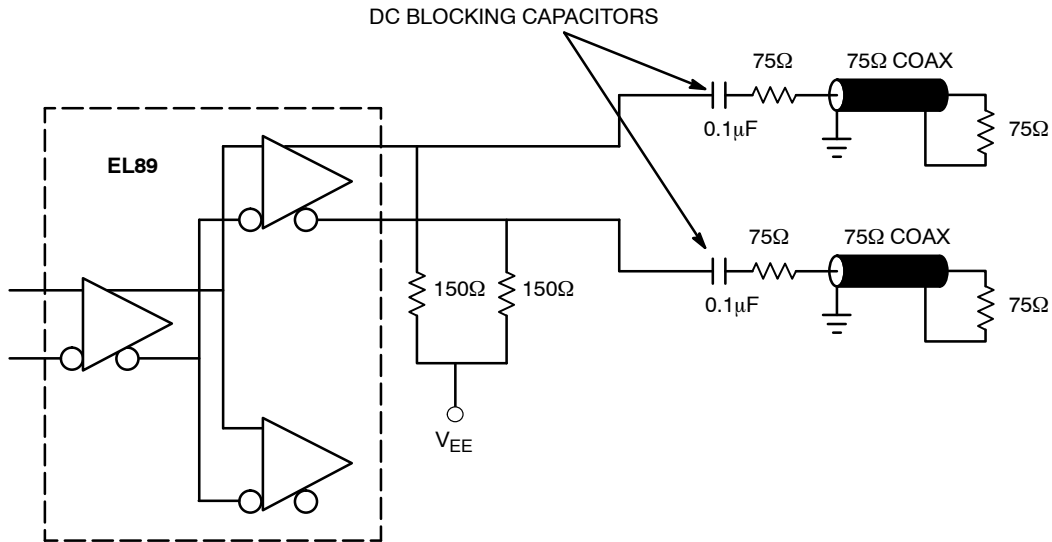


Figure 2. EL89 CATV Termination Configuration

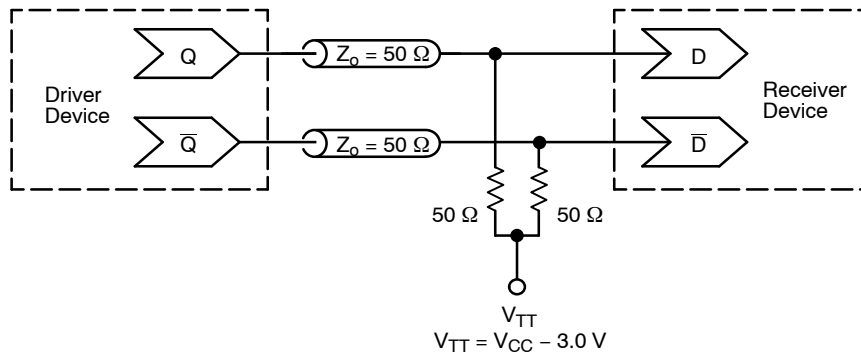


Figure 3. Typical Termination for Output Driver and Device Evaluation
(See Application Note AND8020/D – Termination of ECL Logic Devices.)

MC10EL89

ORDERING INFORMATION

| Device | Package | Shipping† |
|---------------|----------------------|--------------------|
| MC10EL89D | SOIC-8 | 98 Units / Rail |
| MC10EL89DG | SOIC-8 (Pb-Free) | 98 Units / Rail |
| MC10EL89DR2 | SOIC-8 | 2500 / Tape & Reel |
| MC10EL89DR2G | SOIC-8 (Pb-Free) | 2500 / Tape & Reel |
| MC10EL89DT | TSSOP-8 | 100 Units / Rail |
| MC10EL89DTG | TSSOP-8 (Pb-Free) | 100 Units / Rail |
| MC10EL89DTR2 | TSSOP-8 | 2500 / Tape & Reel |
| MC10EL89DTR2G | TSSOP-8 (Pb-Free) | 2500 / Tape & Reel |
| MC10EL89MNR4 | DFN8 | 1000 / Tape & Reel |
| MC10EL89MNR4G | DFN8 (Pb-Free) | 1000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

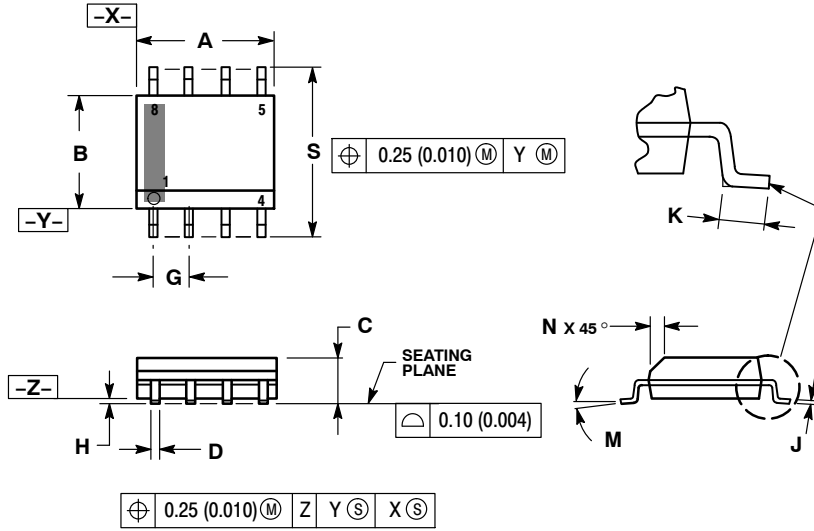
Resource Reference of Application Notes

- AN1405/D** - ECL Clock Distribution Techniques
- AN1406/D** - Designing with PECL (ECL at +5.0 V)
- AN1503/D** - ECLinPS™ I/O SPICE Modeling Kit
- AN1504/D** - Metastability and the ECLinPS Family
- AN1568/D** - Interfacing Between LVDS and ECL
- AN1672/D** - The ECL Translator Guide
- AND8001/D** - Odd Number Counters Design
- AND8002/D** - Marking and Date Codes
- AND8020/D** - Termination of ECL Logic Devices
- AND8066/D** - Interfacing with ECLinPS
- AND8090/D** - AC Characteristics of ECL Devices

MC10EL89

PACKAGE DIMENSIONS

SOIC-8 NB
CASE 751-07
ISSUE AH

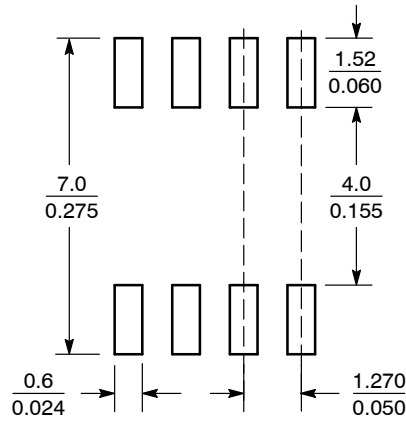


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.80 | 5.00 | 0.189 | 0.197 |
| B | 3.80 | 4.00 | 0.150 | 0.157 |
| C | 1.35 | 1.75 | 0.053 | 0.069 |
| D | 0.33 | 0.51 | 0.013 | 0.020 |
| G | 1.27 BSC | | 0.050 BSC | |
| H | 0.10 | 0.25 | 0.004 | 0.010 |
| J | 0.19 | 0.25 | 0.007 | 0.010 |
| K | 0.40 | 1.27 | 0.016 | 0.050 |
| M | 0° | 8° | 0° | 8° |
| N | 0.25 | 0.50 | 0.010 | 0.020 |
| S | 5.80 | 6.20 | 0.228 | 0.244 |

SOLDERING FOOTPRINT*



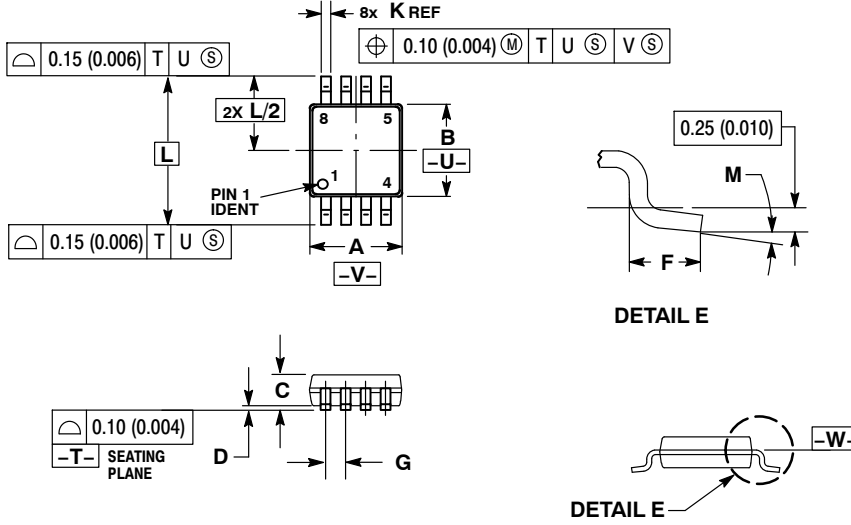
SCALE 6:1 (mm/inches)

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MC10EL89

PACKAGE DIMENSIONS

TSSOP-8
DT SUFFIX
PLASTIC TSSOP PACKAGE
CASE 948R-02
ISSUE A



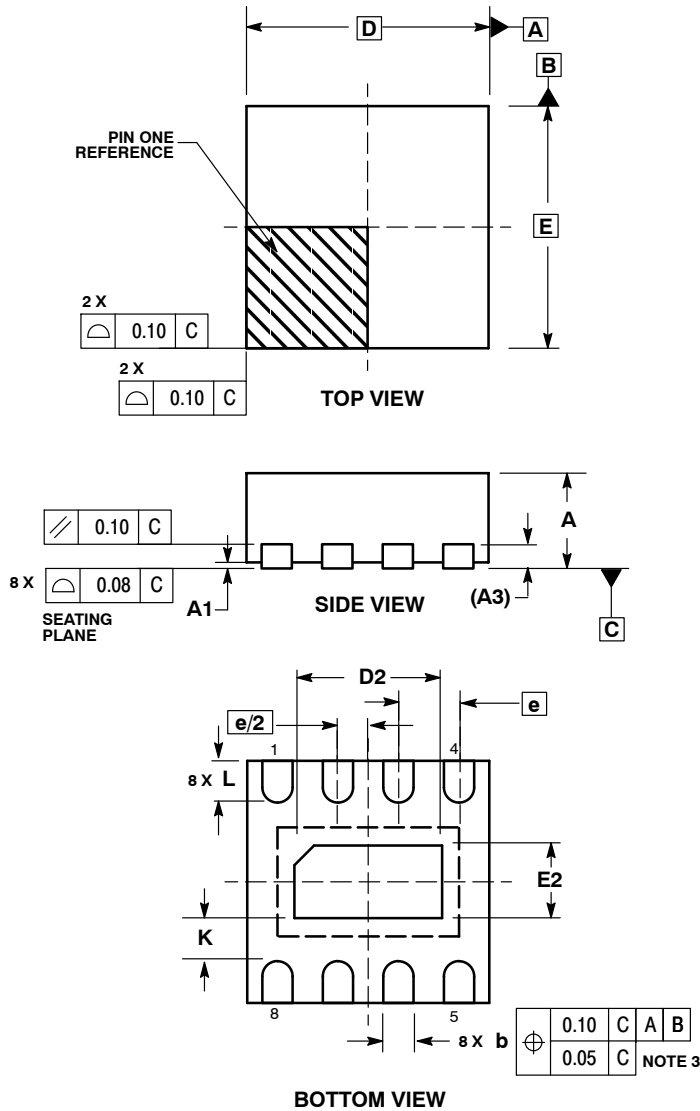
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| | MIN | MAX | MIN | MAX |
| A | 2.90 | 3.10 | 0.114 | 0.122 |
| B | 2.90 | 3.10 | 0.114 | 0.122 |
| C | 0.80 | 1.10 | 0.031 | 0.043 |
| D | 0.05 | 0.15 | 0.002 | 0.006 |
| F | 0.40 | 0.70 | 0.016 | 0.028 |
| G | 0.65 BSC | | 0.026 BSC | |
| K | 0.25 | 0.40 | 0.010 | 0.016 |
| L | 4.90 BSC | | 0.193 BSC | |
| M | 0° | 6° | 0° | 6° |

MC10EL89

PACKAGE DIMENSIONS

DFN8
CASE 506AA-01
ISSUE D



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994 .
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| DIM | MILLIMETERS | |
|-----|-------------|------|
| | MIN | MAX |
| A | 0.80 | 1.00 |
| A1 | 0.00 | 0.05 |
| A3 | 0.20 REF | |
| b | 0.20 | 0.30 |
| D | 2.00 BSC | |
| D2 | 1.10 | 1.30 |
| E | 2.00 BSC | |
| E2 | 0.70 | 0.90 |
| e | 0.50 BSC | |
| K | 0.20 | --- |
| L | 0.25 | 0.35 |

ECLinPS is a trademark of Semiconductor Components INdustries, LLC (SCILLC).

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com
Order Literature: <http://www.onsemi.com/orderlit>
For additional information, please contact your local Sales Representative

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.

